

74F175 Quad D-Type Flip-Flop

General Description

The 74F175 is a high-speed quad D-type flip-flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D inputs is stored during the LOW-to-HIGH clock transition. Both true and complemented outputs of each flip-flop are provided. A Master Reset input resets all flip-flops, independent of the Clock or D inputs, LOW.

Features

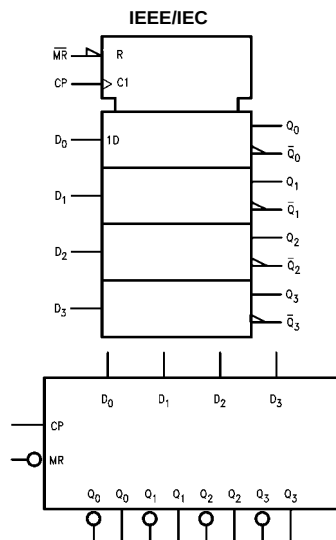
- Edge-triggered D-type inputs
- Buffered positive edge-triggered clock
- Asynchronous common reset
- True and complement output

Ordering Code:

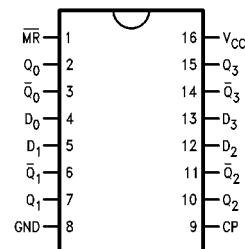
Order Number	Package Number	Package Description
74F175SC	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
74F175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F175PC	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
D_0-D_3	Data Inputs	1.0/1.0	20 μA /-0.6 mA
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 μA /-0.6 mA
$\overline{MR}$	Master Reset Input (Active LOW)	1.0/1.0	20 μA /-0.6 mA
Q_0-Q_3	True Outputs	50/33.3	-1 mA/20 mA
$\overline{Q_0}-\overline{Q_3}$	Complement Outputs	50/33.3	-1 mA/20 mA

Functional Description

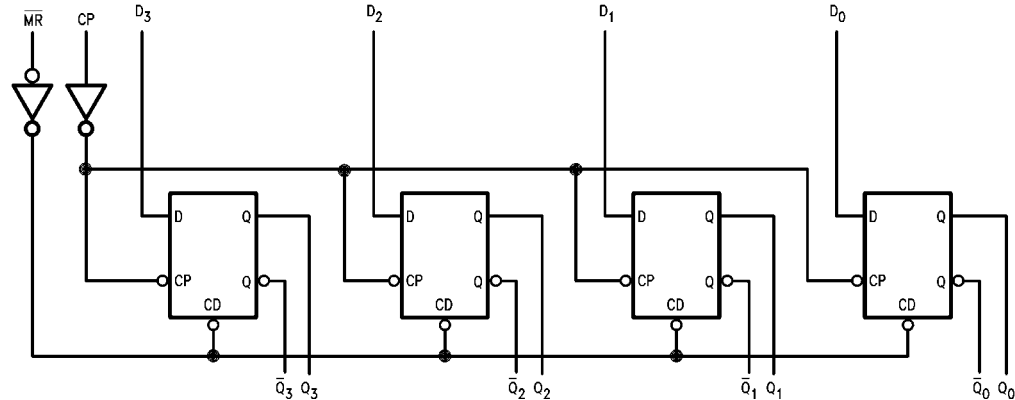
The 74F175 consists of four edge-triggered D-type flip-flops with individual D inputs and Q and $\overline{Q}$ outputs. The Clock and Master Reset are common. The four flip-flops will store the state of their individual D inputs on the LOW-to-HIGH clock (CP) transition, causing individual Q and $\overline{Q}$ outputs to follow. A LOW input on the Master Reset ($\overline{MR}$) will force all Q outputs LOW and $\overline{Q}$ outputs HIGH independent of Clock or Data inputs. The 74F175 is useful for general logic applications where a common Master Reset and Clock are acceptable.

Truth Table

Inputs			Outputs	
$\overline{MR}$	CP	D_n	Q_n	$\overline{Q_n}$
L	X	X	L	H
H	$\nearrow$	H	H	L
H	$\nearrow$	L	L	H

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial
 $\nearrow$ = LOW-to-HIGH Clock Transition

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with V_{CC} = 0V)Standard Output -0.5V to V_{CC}

3-STATE Output -0.5V to +5.5V

Current Applied to Output

in LOW State (Max) twice the rated I_{OL} (mA)**Recommended Operating Conditions**

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	10% V _{CC} 5% V _{CC}	2.5 2.7		V	Min	I _{OH} = -1 mA I _{OH} = -1 mA
V _{OL}	Output LOW Voltage	10% V _{CC}		0.5	V	Min	I _{OL} = 20 mA
I _{IH}	Input HIGH Current			5.0	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test			7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current			3.75	μA	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current			-0.6	mA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current	-60		-150	mA	Max	V _{OUT} = 0V
I _{CC}	Power Supply Current		22.5	34.0	mA	Max	CP =  D _n = MR = HIGH

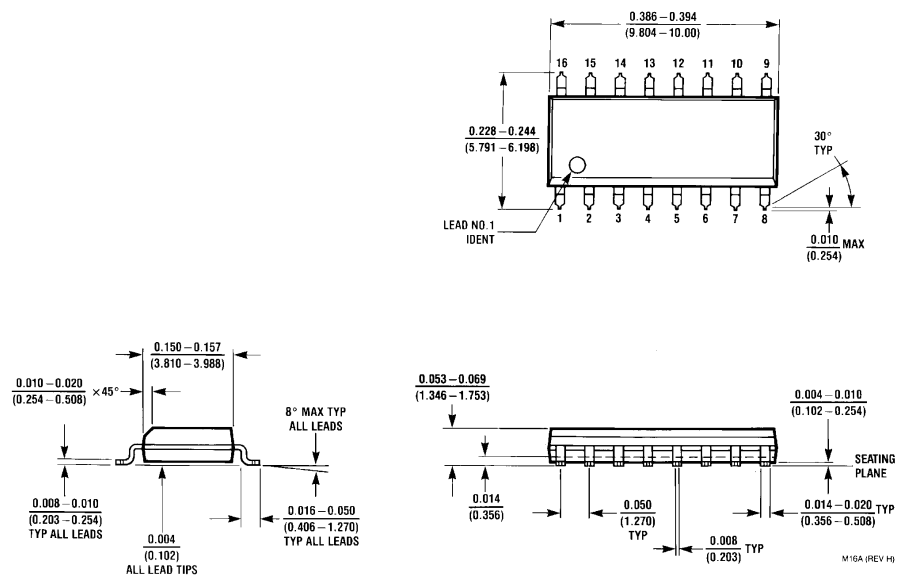
AC Electrical Characteristics

Symbol	Parameter	T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A = -55°C to +125°C V _{CC} = +5.0V C _L = 50 pF		T _A = 0°C to +70°C V _{CC} = +5.0V C _L = 50 pF		Units
		Min	Typ	Max	Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	100	140		80		100		MHz
t _{PLH}	Propagation Delay CP to Q _n or $\overline{Q}_n$	4.0	5.0	6.5	3.5	8.5	4.0	7.5	ns
t _{PHL}	Propagation Delay $\overline{MR}$ to Q _n	4.0	6.5	8.5	4.0	10.5	4.0	9.5	
t _{PHL}	Propagation Delay $\overline{MR}$ to Q _n	4.5	9.0	11.5	4.5	15.0	4.5	13.0	ns
t _{PLH}	Propagation Delay $\overline{MR}$ to $\overline{Q}_n$	4.0	6.5	8.0	4.0	10.0	4.0	9.0	ns

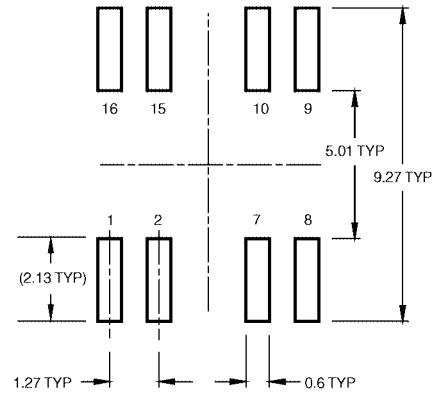
AC Operating Requirements

Symbol	Parameter	T _A = +25°C V _{CC} = +5.0V		T _A = -55°C to +125°C V _{CC} = +5.0V		T _A = 0°C to +70°C V _{CC} = +5.0V		Units
		Min	Max	Min	Max	Min	Max	
t _S (H)	Setup Time, HIGH or LOW	3.0		3.0		3.0		ns
t _S (L)	D _n to CP	3.0		3.0		3.0		
t _H (H)	Hold Time, HIGH or LOW	1.0		1.0		1.0		
t _H (L)	D _n to CP	1.0		2.0		1.0		
t _W (H)	CP Pulse Width	4.0		4.0		4.0		ns
t _W (L)	HIGH or LOW	5.0		5.0		5.0		
t _W (L)	$\overline{MR}$ Pulse Width, LOW	5.0		5.0		5.0		ns
t _{REC}	Recovery Time, $\overline{MR}$ to CP	5.0		5.0		5.0		ns

Physical Dimensions inches (millimeters) unless otherwise noted



**16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A**



Technical drawing of a 2x2 pin connector showing dimensions and tolerances:

- Overall height: 2.1 MAX.
- Pin height: 1.8 ± 0.1
- Pin pitch: 1.27 TYP
- Pin diameter: 0.15 ± 0.05
- Pin spacing: 0.35-0.51
- Pin diameter tolerance: 0.12
- Pin material: C/A
- Pin finish: ALL LEAD TIPS
- Pin plating: 0.1 C
- Pin coating: -C

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION,
ESTABLISHED IN DECEMBER, 1998.

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
FLASH, AND TIE BAR EXTRUSIONS.

7° TYP

0°-8° TYP

GAGE PLANE

0.60±0.15

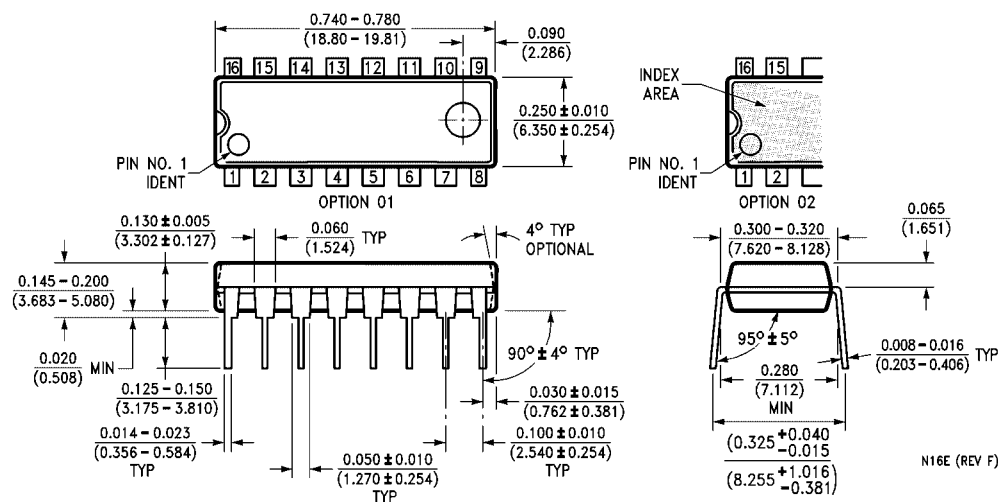
1.25

0.25

SEATING PLANE

DETAIL A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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